# 504270495 03/14/2017

# PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:		NE	NEW ASSIGNMENT			
NATURE OF CONVEYANCE:		AS	ASSIGNMENT			
CONVEYING PARTY DA	ATA					
			Name		Execution Date	
ZHENG ZHANG					03/10/2017	
FUQIU YE					03/12/2017	
QIN CHENG					03/10/2017	
RENGUI BI					03/10/2017	
RECEIVING PARTY DA	ТА					
Name:	JIAOTU CO., LTD.					
Street Address:	NO. 78 KELING ROAD, SOFTWARE PARK					
Internal Address:	SUZHOU SCIENCE & TECHNOLOGY TOWN					
City:	SUZHOU					
State/Country:	CHINA					
Postal Code:	215163					
PROPERTY NUMBERS Total: 1 Property Type			Number			
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	e sent to provided	l <i>; if that i</i> mmip.ser MING JI <i>I</i> 455 BAR	<i>nail address first; if that is ur is unsuccessful, it will be se</i> rvicesllc@yahoo.com ANG RNESLEY LANE RETTA, GEORGIA 30022			
ATTORNEY DOCKET NUMBER:		01	011-001-US			
NAME OF SUBMITTER:			MING JIANG			
SIGNATURE:			/MING JIANG/			
DATE SIGNED:			03/14/2017			
Total Attachments: 2 source=011-001-US-ASSI source=011-001-US-ASSI						

# ASSIGNMENT

IN CONSIDERATION of the sum of One Dollar (\$1.00), and of other good and valuable consideration paid to the undersigned by the Assignee,

#### JIAOTU CO., LTD.

a corporation organized under the laws of China, domiciled at

### NO.78, KELING ROAD, SOFTWARE PARK SUZHOU SCIENCE&TECHNOLOGY TOWN, SUZHOU, HANGSU, CHINA

receipt whereof is hereby acknowledged, the undersigned by these presents hereby sells, assigns, transfers, and sets over unto said assignee the entire right, title and interest in and to the invention or improvement in

## "SENSING CIRCUIT, PROCESSING METHOD OF SENSING CIRCUIT AND CURVED SURFACE PROFILE MEASURING METHOD THEREOF"

said invention being fully described and/or claimed in the application for Letters Patent of the United States of America, executed this date, as well as any divisional, continuing, reissue, reexamination, or other patent applications, in and for the United States and all foreign countries, the same to be held and enjoyed by said assignee, its successors, assigns or other legal representatives, to the full ends of the terms for which all Letters Patent therefore may be granted, as fully and entirely as the same would have been held and enjoyed by the undersigned if this assignment and sale had not been made.

AND SAID ASSIGNEE IS HEREBY AUTHORIZED to make application for and to receive Letters Patent for said invention in any of said countries at its election.

AND BY THIS COVENANT the undersigned will execute or procure any further necessary assurance of title to said invention and Letters Patent; and at any time, upon the request of said assignee, will execute and deliver any and all papers that may be necessary or desirable to perfect the title to said invention or any Letters Patent which may be granted therefor to said Assignee, its successors, assigns or other legal representatives, and, upon the request of said assignee, will execute any divisional, continuing, reissue, reexamination, or other applications for patents for said invention, in any country, and will make all rightful oaths and do all lawful acts requisite for aiding, procuring, or maintaining the same or for aiding therein.

AND THE COMMISSIONER of Patents is hereby authorized and requested to issue any and all Letters Patent to the United States for said invention, to said assignee.

SIGNED as indicated below.

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PATENT REEL: 041994 FRAME: 0206

Signature: 2hong 2hang
Name:ZHENG ZHANG
Date: 2017. 3.10
Signature :
Name: FUQIU YE
Date: 207.3.12
Signature : <u>QIN MENG</u>
Name: QIN CHENG
Date: 2017. 3.10
Signature: <u>RENGUIM</u>
Name:RENGUI BI
Date: 2017, 3.10

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RECORDED: 03/14/2017